

CD54AC257/3A CD54ACT257/3A

Quad 2-Input Multiplexer
Three-State, Non-Inverting

**COMPLETE DATA SHEET
COMING SOON!**

June 1997

Description

The CD54AC257/3A and CD54ACT257/3A are quad 2-input multiplexers with three-state outputs. These devices utilize the Harris Advanced CMOS Logic technology. Each of these devices selects four bits of data from two sources under the control of a common Select input (S). The Output Enable (\overline{OE}) is active LOW. When \overline{OE} is HIGH, all of the outputs (Y) are in the high-impedance state regardless of all other input conditions.

Moving data from two groups of registers to four common output buses is a common use of the CD54AC/ACT257/3A. The state of the Select input determines the particular register from which the data comes. The CD54AC/ACT257/3A can also be used as function generators.

The CD54AC257/3A and CD54ACT257/3A are supplied in 16 lead dual-in-line ceramic packages (F suffix).

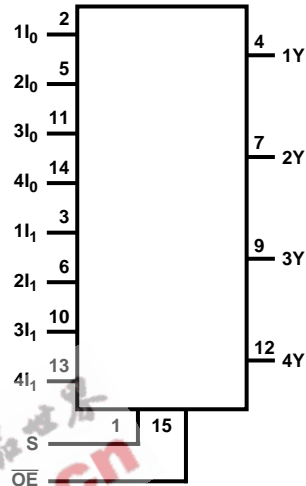
ACT INPUT LOAD TABLE

| INPUT | UNIT LOAD (NOTE 1) |
|-----------------|--------------------|
| Data | 0.83 |
| S | 1.27 |
| \overline{OE} | 1.27 |

NOTE:

- Unit load is ΔI_{CC} limit specified in DC Electrical Specifications Table, e.g., 2.4mA Max at +25°C.

Functional Diagram



Absolute Maximum Ratings

DC Supply Voltage, V_{CC} -0.5V to +6V
 DC Input Diode Current, I_{IK}
 For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$ $\pm 20mA$
 DC Output Diode Current, I_{OK}
 For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ $\pm 50mA$
 DC Output Source or Sink Current, Per Output Pin, I_O
 For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$ $\pm 50mA$
 DC V_{CC} or GND Current, I_{CC} or I_{GND}
 For Up to 4 Outputs Per Device, Add $\pm 25mA$ For Each
 Additional Output $\pm 100mA$

Power Dissipation Per Package, P_D
 $T_A = -55^\circ C$ to $+100^\circ C$ (Package F) 500mW
 $T_A = +100^\circ C$ to $+125^\circ C$ (Package F) Derate Linearly at
 8mW/ $^\circ C$ to 300mW
 Operating Temperature Range, T_A
 Package Type F $-55^\circ C$ to $+125^\circ C$
 Storage Temperature, T_{STG} $-65^\circ C$ to $+150^\circ C$
 Lead Temperature (During Soldering)
 At Distance 1/16in. \pm 1/32in. (1.59mm \pm 0.79mm)
 From Case For 10s Max $+265^\circ C$
 Unit Inserted Into a PC Board (Min Thickness 1/16in., 1.59mm)
 With Solder Contacting Lead Tips Only $+300^\circ C$

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Recommended Operating Conditions

Supply Voltage Range, V_{CC}
 Unless Otherwise Specified, All Voltages Referenced to GND
 T_A = Full Package Temperature Range
 CD54AC Types 1.5V to 5.5V
 CD54ACT Types 4.5V to 5.5V
 DC Input or Output Voltage, V_I , V_O 0V to V_{CC}

Operating Temperature, T_A $-55^\circ C$ to $+125^\circ C$
 Input Rise and Fall Slew Rate, dt/dv
 at 1.5V to 3V (AC Types) 0ns/V to 50ns/V
 at 3.6V to 5.5V (AC Types) 0ns/V to 20ns/V
 at 4.5V to 5.5V (AC Types) 0ns/V to 10ns/V